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## Stress analysis of plate with opposite semicircular notches and adhesively bonded piezoelectric actuators

(Conference Paper) [\(Open Access\)](#)

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### Abstract

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Stress control of structures by means of active smart material has evolved in recent years. The structure's stress control can typically be considered as strengthening that effects the structure's load-carrying capability. The stress-concentration cause by holes and notches produces a large variation and significant increase in stress. The control of the stress concentration and its distributions in the notched area is valuable for many practical and design applications. This study investigates the impacts of the piezoelectric actuators on control of the stress concentration factor (SCF) for an aluminum plate with opposite semicircular notches. Finite-element method (FEM) is used to access the SCFs due to external static loading. The stress control efficiency is assessed by the SCFs as an effectiveness criterion. The results indicate that SCFs reduces linearly with active piezoelectric actuator. Copyright © 2020 Ahmed Abuzaid, et al. This is an open access article distributed under the Creative Commons Attribution License, which permits unrestricted use, distribution, and reproduction in any medium, provided the original work is properly cited.

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Topic: Crack Tips | Stress Intensity Factors | Patch

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### Author keywords

FEM Piezoelectric actuator Smart material Stress concentration factor

### Indexed keywords

Engineering controlled terms: Adhesives Piezoelectricity Plates (structural components) Stress analysis Stress concentration Stress intensity factors

Engineering uncontrolled terms: Adhesively bonded Design applications Load carrying capability Semicircular notch Static loading Stress concentration factors Stress control

Engineering main heading: Piezoelectric actuators

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## References (16)

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- 
- 1 Pilkey, W.D., Pilkey, D.F.  
Peterson's stress concentration factors  
(2008) *Peterson's Stress Concentration Factors*. Cited 965 times.  
John Wiley and Sons
- 
- 2 Giare, G.S., Shabahang, R.  
The reduction of stress concentration around the hole in an isotropic plate using composite materials  
  
(1989) *Engineering Fracture Mechanics*, 32 (5), pp. 757-766. Cited 15 times.  
doi: 10.1016/0013-7944(89)90172-0  
  
[View at Publisher](#)
- 
- 3 Meguid, S.A.  
Finite element analysis of defence hole systems for the reduction of stress concentration in a uniaxially-loaded plate with two coaxial holes  
  
(1986) *Engineering Fracture Mechanics*, 25 (4), pp. 403-413. Cited 27 times.  
doi: 10.1016/0013-7944(86)90254-7  
  
[View at Publisher](#)
- 
- 4 Wu, Z.  
Optimal hole shape for minimum stress concentration using parameterized geometry models  
  
(2009) *Structural and Multidisciplinary Optimization*, 37 (6), pp. 625-634. Cited 19 times.  
doi: 10.1007/s00158-008-0253-4  
  
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- 
- 5 Liu, T.J.C.  
Fracture mechanics and crack contact analyses of the active repair of multi-layered piezoelectric patches bonded on cracked structures  
  
(2007) *Theoretical and Applied Fracture Mechanics*, 47 (2), pp. 120-132. Cited 26 times.  
doi: 10.1016/j.tafmec.2006.11.004  
  
[View at Publisher](#)
- 
- 6 Abuzaid, A., Hrairi, M., Dawood, M.S.I.S.  
Survey of active structural control and repair using piezoelectric patches ([Open Access](#))  
  
(2015) *Actuators*, 4 (2), pp. 77-98. Cited 11 times.  
<http://www.mdpi.com/2076-0825/4/2/77/pdf>  
doi: 10.3390/act4020077  
  
[View at Publisher](#)
- 
- 7 Alaimo, A., Milazzo, A., Orlando, C.  
On the dynamic behavior of piezoelectric active repair by the boundary element method  
  
(2011) *Journal of Intelligent Material Systems and Structures*, 22 (18), pp. 2137-2146. Cited 15 times.  
doi: 10.1177/1045389X11425281  
  
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-

- 8 Rogers, C.A.  
Intelligent Material Systems – The Dawn of a New Materials Age (Open Access)  
(1993) *Journal of Intelligent Material Systems and Structures*, 4 (1), pp. 4-12. Cited 79 times.  
doi: 10.1177/1045389X9300400102  
View at Publisher
- 
- 9 Shah, D.K., Chan, W.S., Joshi, S.P.  
Finite element analysis of plates with piezoelectric layers  
(1993) *Collection of Technical Papers - AIAA/ASME Structures, Structural Dynamics and Materials Conference*, (pt 6), pp. 3189-3197. Cited 12 times.  
doi: 10.2514/6.1993-1678  
View at Publisher
- 
- 10 Fesharaki, J.J., Golabi, S.  
Effect of stiffness ratio of piezoelectric patches and plate on stress concentration reduction in a plate with a hole  
(2017) *Mechanics of Advanced Materials and Structures*, 24 (3), pp. 253-259. Cited 4 times.  
<http://www.tandf.co.uk/journals/titles/15376494.html>  
doi: 10.1080/15376494.2016.1139214  
View at Publisher
- 
- 11 Jafari Fesharaki, J., Madani, S.G., Golabi, S.  
Best pattern for placement of piezoelectric actuators in classical plate to reduce stress concentration using PSO algorithm  
(2020) *Mechanics of Advanced Materials and Structures*, 27 (2), pp. 141-151. Cited 3 times.  
<http://www.tandf.co.uk/journals/titles/15376494.html>  
doi: 10.1080/15376494.2018.1472332  
View at Publisher
- 
- 12 Fesharaki, J.J., Golabi, S.  
A novel method to specify pattern recognition of actuators for stress reduction based on particle swarm optimization method  
(2016) *Smart Structures and Systems*, 17 (5), pp. 725-742. Cited 11 times.  
<http://technopress.kaist.ac.kr/download.php?journal=sss&volume=17&num=5&ordernum=3>  
doi: 10.12989/sss.2016.17.5.725  
View at Publisher
- 
- 13 Abuzaid, A., Hrairi, M., Shaik Dawood, M.S.I.  
Estimation of Stress Concentration Factor of Plate with Hole using Piezoelectric Actuator and Finite Element Method (Open Access)  
(2017) *IOP Conference Series: Materials Science and Engineering*, 184 (1), art. no. 012064. Cited 3 times.  
<http://www.iop.org/EJ/journal/mse>  
doi: 10.1088/1757-899X/184/1/012064  
View at Publisher
- 
- 14 Tada, H., Paris, P.C., Irwin, G.R.  
(2000) *The Stress Analysis of Cracks Handbook*. Cited 1925 times.  
3rd Edition
-

- 15 Crawley, E.F., De Luis, J.  
Use of piezoelectric actuators as elements of intelligent structures

(1987) *AIAA Journal*, 25 (10), pp. 1373-1385. Cited 2288 times.  
doi: 10.2514/3.9792

[View at Publisher](#)

- 16 (1988) *IEEE Standard on Piezoelectricity*. Cited 1847 times.  
ANSI/IEEE Std 176-1987

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